US 20240237379A1

(19) United States

(12) Patent Application Publication (10) Pub. No.: US 2024/0237379 A1

MEI (43) Pub. Date: Jul. 11, 2024

(54) **LIGHT EMITTING DEVICE AND MANUFACTURING METHOD THEREOF, DISPLAY SUBSTRATE AND DISPLAY APPARATUS**

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(21) Appl. No.: **17/913,224**

(22) PCT Filed: **Aug. 27, 2021**

(86) PCT No.: **PCT/CN2021/115151**

§ 371 (c)(1),
(2) Date: **Mar. 2, 2023**

Publication Classification

(51) **Int. Cl.**

H10K 50/115	(2006.01)
C09K 11/06	(2006.01)
H10K 71/12	(2006.01)
H10K 85/60	(2006.01)

(52) **U.S. Cl.**

CPC ***H10K 50/115*** (2023.02); ***C09K 11/06*** (2013.01); ***H10K 71/12*** (2023.02); *H10K 85/631* (2023.02)

(57) **ABSTRACT**

The present disclosure provides a light emitting device, a manufacturing method thereof, a display substrate, and a display apparatus. The light emitting device includes a first carrier transport layer, a light emitting layer and a second carrier transport layer sequentially stacked on a substrate, wherein the light emitting layer includes at least two quantum dot film layers, each of which includes quantum dots; the quantum dot film layer close to the first carrier transport layer further includes carrier auxiliary ligands, each of which is configured to be attached to a surface of a body of the quantum dot, and/or the quantum dot film layer close to the second carrier transport layer further includes carrier auxiliary ligands, each of which is configured to be attached to a surface of a body of the quantum dot.